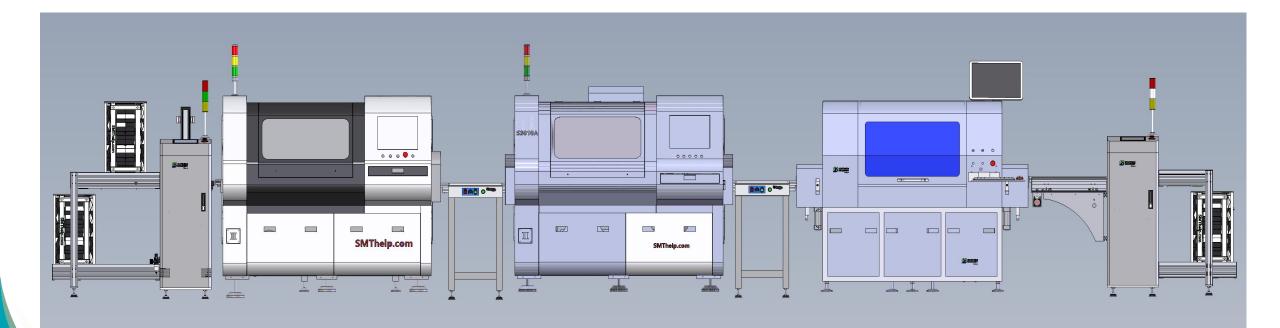


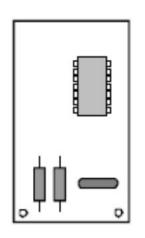
This design requirements refer to IPC and according to the basic requirements of THT process experience. However, it is not a permanent standard, the change of equipment model, specific machine production plant or quality requirements and IPC standard update will be changed. If you have any questions, please contact : info@SMThelp.com

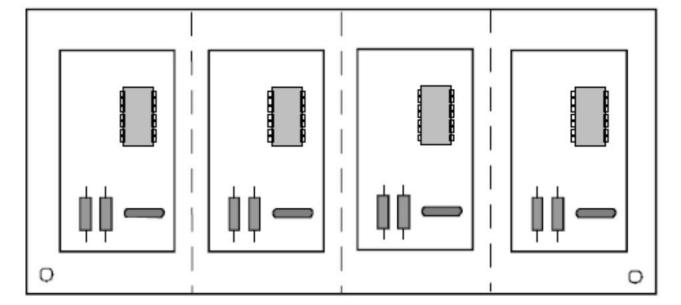




PCB Board Panelization

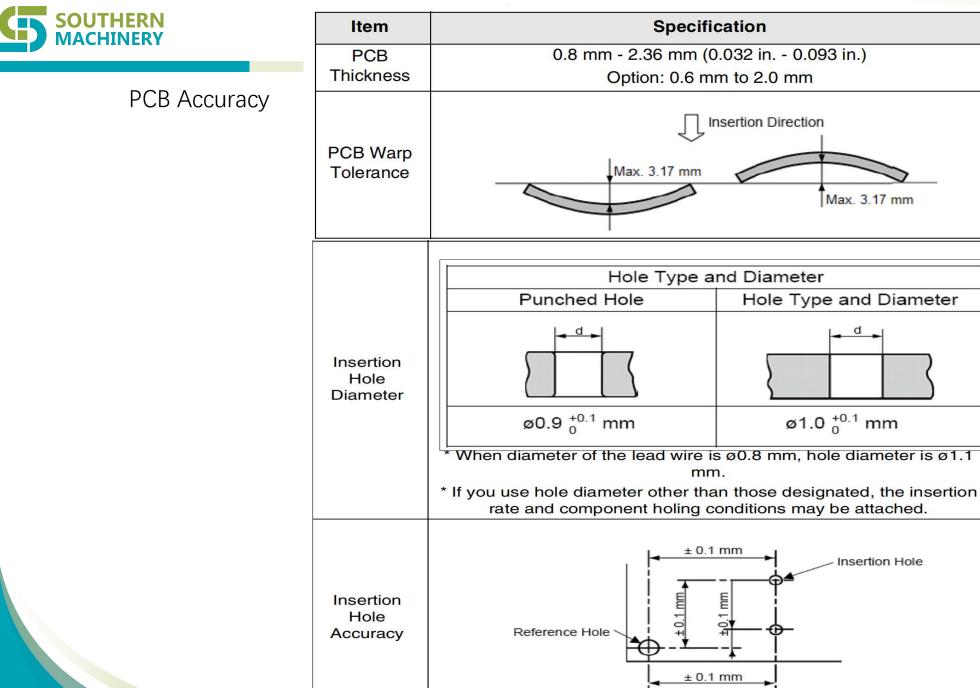
Throughput can be increased by positioning small PCBs into multiple breakaway panels or arrays or both. Standardization of panel size will reduce setup time during job changeover.





Single Printed Circuit Board

4 Circuit Panel/Array



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Hole Variability between PCBs must be within ±0.1 mm.



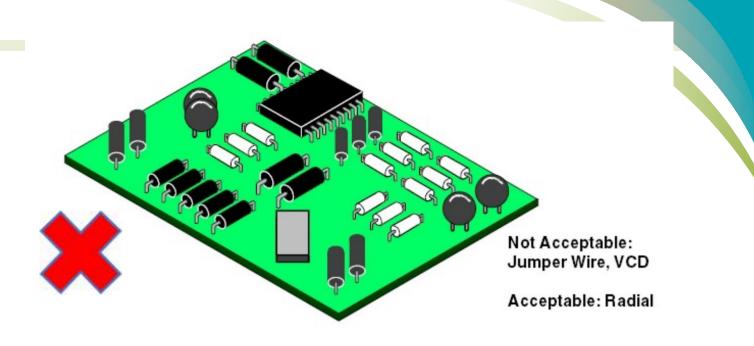
THT Insertion hole

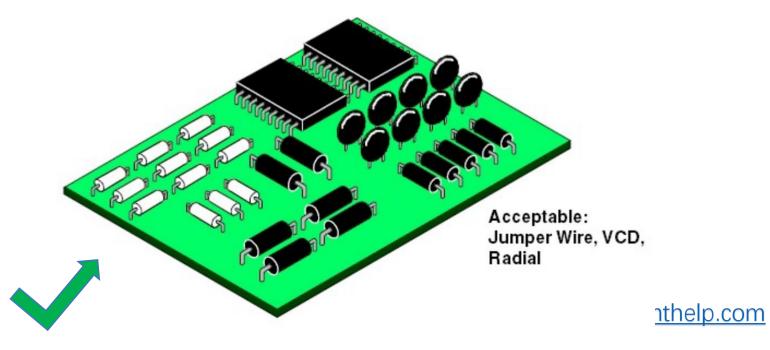
Axial and Radial Component (Lead Diameter $\psi \leq 0.8$ mm)

	Hole Type and Diameter	
	Punched Hole	Drilled Hole
Lead Diameter	ψ	ψ
ψ 0.8±0.05	ψ 1.2~1.3	ψ 1.3~1.4
ψ 0.6±0.05	ψ 1.0~1.1	ψ 1.2~1.3
ψ 0.5±0.05	ψ 0.98~1.05	ψ 1.1~1.2
ψ 0.4±0.05	ψ 0.8~0.9	ψ 1.0~1.1



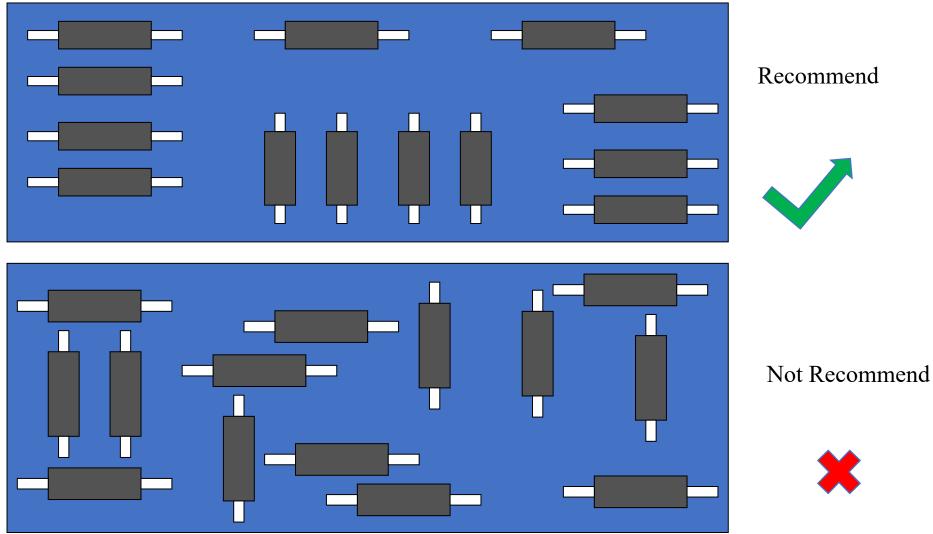
Radial Machines: Capability of inserting components is from 0° to 360°. For maximum throughput, insert from 0° to 90°.





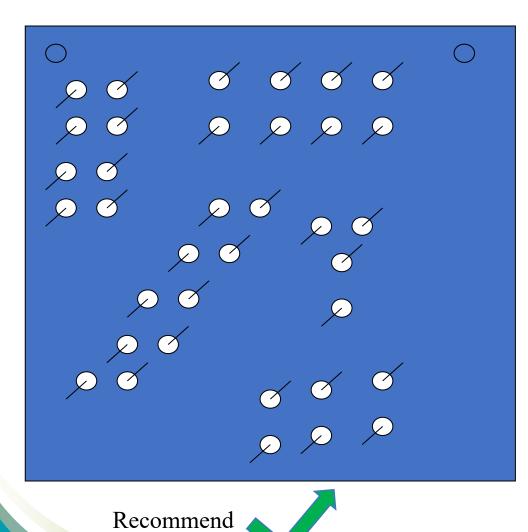


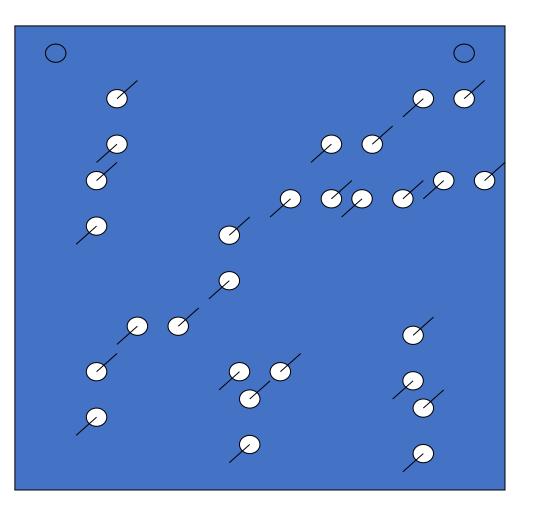
Axial Insertion Lead Clinching Layout





Radial Insertion Lead Clinching Layout



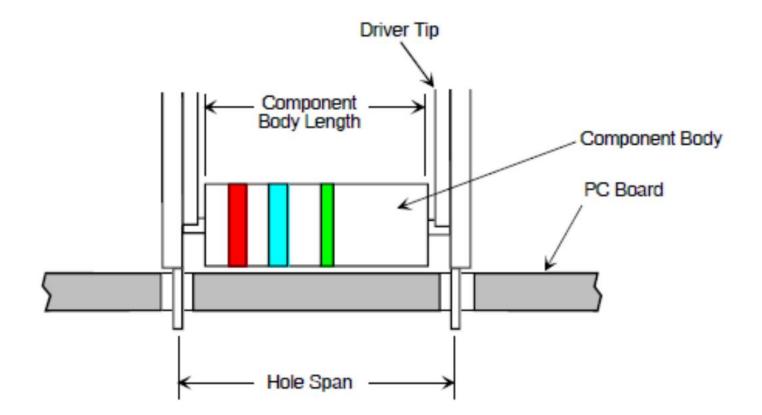


Not Recommend 🛛 🗙





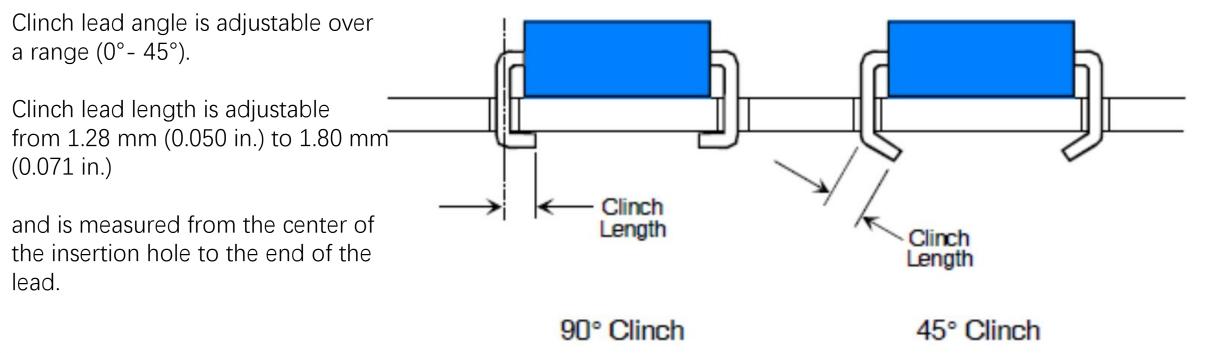
Axial Insertion Hole Span Formulas for Various Body Lengths



Minimum Hole Span = [(Component Body Length1 x 1.109) + 1.40 mm] - Lead Diameter



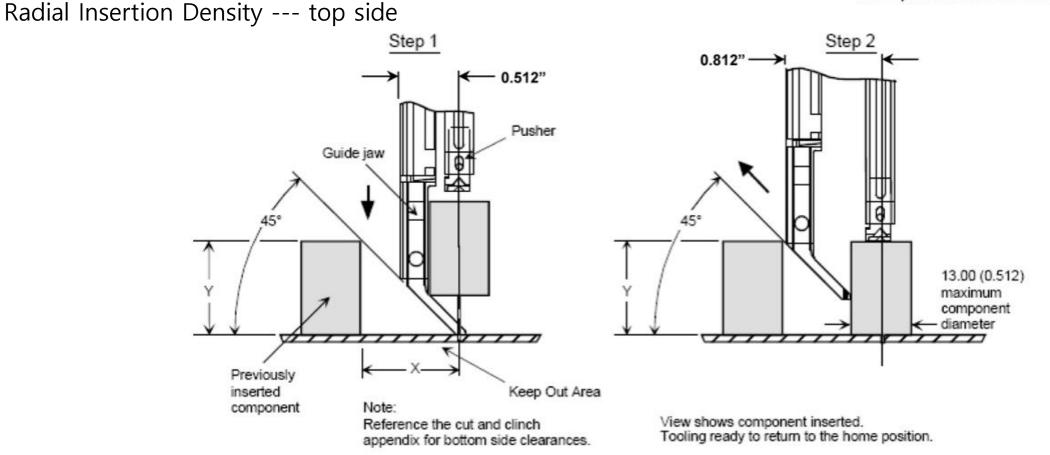
Clinch Lengths and Angles:



Clinch Pattern Options



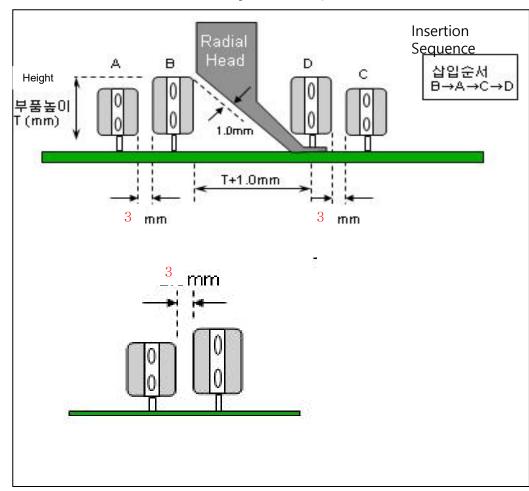
Dimensions are in millimeters; inch equivalents are bracketed.

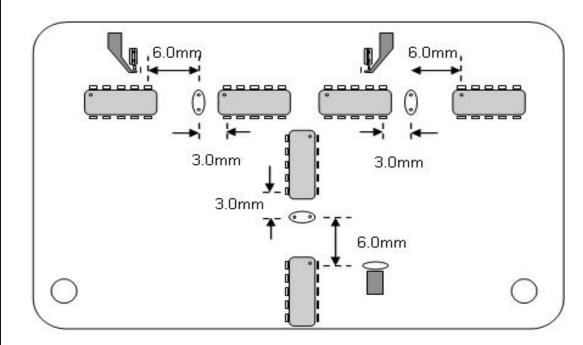


Formula: X (Keep Out Area) = Y (Previously Inserted Component Height) + 0.48 mm (0.019")



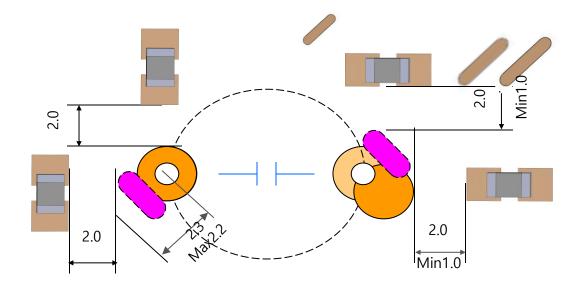
Radial Insertion Density --- top side

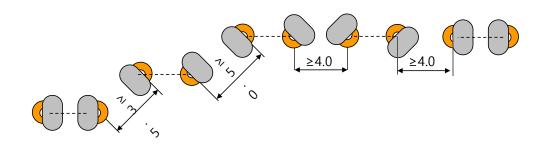






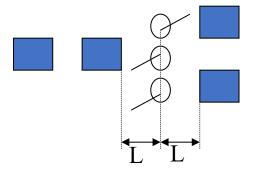
THT & SMD Pad distance





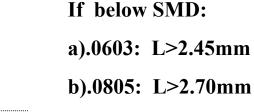


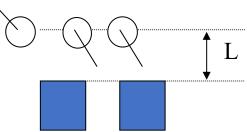
Radial &SMD



L>2.375mm

Note: to avoid short circuit, the gap Radial Lead to SMD PAD >=0.76mm





c).1206: L>2.75mm

d).Other components are determined by the actual body size and the amount of glue

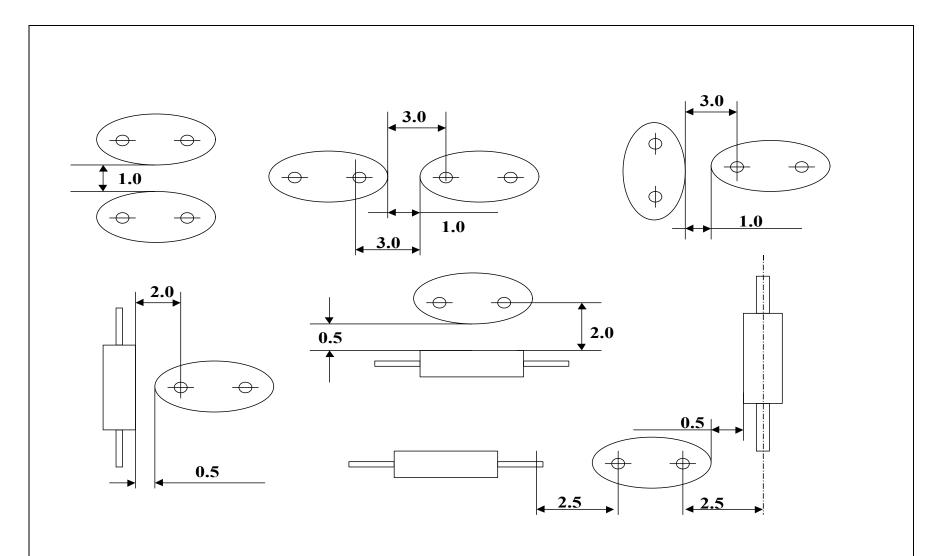
Note: Considering that when the copper mesh treatment tool is printed, the edge of the copper mesh groove touches the foot of the element, resulting in no glue printing

Note: If the component body is greater than the PAD, confirm the lower glue position. Generally speaking, the component body is used as the reference for the SMD components.

Axial & Radial : Hole pitch, Gap of components

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